

Faster – better – everywhere.



## SK 3312.540 Liquid Cooling Package

POWER DISTRIBUTION SCIENCE CONTROL

State: 16/9/2025 (Source: rittal.com/in-en)



IT INFRASTRUCTURE SOFTWARE & SERVICES

FRIEDHELM LOH GROUP

ENCLOSURES

# SK 3312.540 - Liquid Cooling Package LCP Inline CW, LCP Inline CWG

Bayed climate control designed for siting within a bayed enclosure suite. The hot air is extracted at the rear of the unit, cooled and then expelled forwards to the cold aisle.

#### Features

Model No.	SK 3312.540
Benefits	Maximum energy efficiency due to EC fan technology and IT-based control
	Minimal pressure loss at the air end, which in turn minimises the power consumption of the fans
	Optimum adaptability due to dynamic, continuous control of the cold water volume flow
	By using high water inlet temperatures, the proportion of indirect free cooling is increased, which in turn reduces operating costs Targeted cooling output due to modular fan units
	Fan modules configurable as n+1 redundancy
	Standard 3-phase connection for electrical redundancy
	With redundant temperature sensor integrated at the air end as standard
	The separation of cooling and enclosure prevents the ingress of water into the server enclosure
	A footprint of max. 0.36 m <sup>2</sup> for all cooling services
	Improved heat recovery, thanks to high water return temperatures when using LCP CW glycol variants, for example in combination with a heat pump
	Optimum access for maintenance and servicing from the front and rear
	Tool-free replacement of the fan modules
Function principle	The hot air is drawn in from the room or hot aisle at the rear of the
	device and expelled at the front into the cold aisle after cooling.
	With this product, a raised floor is not necessary.
Material	Sheet steel, spray-finished
Colour	RAL 7035

#### Features

Options	Direct connection of additional CMC III sensors is supported Racks 2200 mm high
Design	Suite cooling
Monitoring	Monitoring of all system-relevant parameters such as server air intake temperature, server waste air temperature, water inlet/return temperature, water flow, cooling output, fan speed, leakage Direct connection of the unit via SNMP over Ethernet Integration into RiZone
Total cooling output/Number of fan modules	18 kW/2 27 kW/3 30 kW/4
Air throughput (unimpeded air flow)	At 50 Hz: 5,000 m³/h
Number of fan modules in supplied state	2
Dimensions	Width: 300 mm Height: 2,000 mm Depth: 1,200 mm
Installation in bayed enclosure suite	Flush
Rated operating voltage	230 V, 1~, 50 Hz/60 Hz 400 V, 3~, 50 Hz/60 Hz
Max. cooling output	30 kW
Type of electrical connection	Connector
Duty cycle	100 %
Cooling medium	Water
EC fan	Yes
Fans may be exchanged with the system operational	Yes
Temperature control	Linear fan control Two-way control valve
Water connections	DN 40 (G 1½" external thread)

#### Features

Permissible operating pressure (p. max.)	10 bar
Water inlet temperature	15 °C
Protection category to IEC 60 529	IP 20
Options	Direct connection of additional CMC III sensors is supported Racks 2200 mm high
Packs of	1 pc(s).
Net weight	232
Gross weight	235
Customs tariff number	84186900
EAN	4028177811645
ETIM 9	EC002515
ETIM 8	EC002515
ECLASS 8.0	27180712

### Approvals

Certificates

EAC

#### Tender text

LCP Inline CW, flush, 3312.540 WHD (mm) 300 x 2000 x 1200

LCP Inline CW, flush, 3312.540:

Construction of the device optimised for data centres. The integrated air/water heat exchanger ensures a cooling output of up to 30kW with standard server enclosure dimensions, the lowest possible weight and a comprehensive monitoring option.

The heat exchanger is mounted laterally on the rack.

The LCP Inline DX extracts the hot exhaust air from the server via a perforated rear door and blows the cooled air forward via a perforated front door in front of the perforated doors of the server racks, so that is thus available again for the 19" components.

The LCP Inline aligns flush with the server racks in the front and rear areas, forming one continuous alignment.

Maximum efficiency is achieved and the consumption of electrical energy is minimised by using two built-in EC fan modules (cooling output up to 18 kW).

The maximum cooling output of 30 kW is achieved by installing two additional fan modules (accessories).

This provides investment security if the full cooling output does not need to be used at the beginning of the installation.

The device is ready to take a maximum of four EC fan modules. A full fan configuration is therefore possible for reasons of redundancy or to minimise electrical power consumption.

The air/water heat exchanger and server rack are arranged in rows though access is separate in each case. This prevents water penetrating into the server rack and makes installation and service easier.

Access to the adjacent IT rack via the LCP is not possible.

A leak detection feature is integrated. A sensor installed in the condensate tray detects leaks, the main controller then issues an alarm message and/or interrupts the supply of cooling medium into the device. The device has been designed solely to provide a sensitive cooling output.

The water connection can be made optionally downwards or upwards by means of an accessory kit

(1 1/2" external thread).

Short device commissioning time, thanks to simple and fast venting. The fans can be replaced at any time, very quickly and without using tools.

A highly developed network-integration software concept for monitoring/setting all the technical parameters is integrated as default.

Should the controller fail, an integrated fail-safe operation mode ensures reliable cooling.

Up to eight additional sensors (temperature, humidity, etc.) can be connected.

Technical details:

Sensitive cooling output with two/three/four fans: 18/27/30 kW Installed fans: 2 (max. 4 possible) Volumetric air flow: 5,000 m<sup>3</sup>/h (4 fans) Cooling output (three fans): 30 kW Max. air inlet temperature 24°C Inlet temperature: 15°C Medium: water Cooling medium throughput: approx. 60 l/min Pressure loss: approx. 0.6bar Water connection: 1 <sup>1</sup>/<sub>2</sub>" external thread Voltage: 230 V, 1~, 50/60 Hz, 400 V, 3~, N, 50/60 Hz Connected electrical load (four fan modules) at 30 kW cooling output: 1.000 W Max. connected electrical load (four fan modules): 2.100 W Server air inlet temperature control via flow rate control and EC fan fitted with linear speed controller Colour: RAL 7035 Dimensions: W x H x D: 300 x 2000 x 1200 mm Weight as delivered: approx. 260 kg Controllers/interfaces: Network interface (RJ 45) Ethernet as per IEEE 802.3 via 10/100BaseT with PoE Front USB interface: Mini USB for system setting Rear USB interface: for USB stick, for data recording up to 32 GB Front SD-HC slot: 1x up to 32 GB, data recording Alarm relay output: change-over contact for safety extra-low voltage (24 V DC, 1 A) Digital inputs: 2x (terminal) Protocols, Ethernet: TCP/IPv4, TCP/IPv6, SNMPv1, SNMPv2c, SNMPv3, Telnet, SSH, (S)FTP, HTTP (S), NTP, DHCP, DNS, SMTP (S), Syslog

Eight additional sensors (temperature, humidity, etc.) can be connected.

Software

Control based on server inlet temperature Automatic or manual control can be selected Remote control via SNMP is possible Water-side delta-T control for efficient chiller operation can be selected The programming of logical links (tasks) to automate specific processes is possible

Special features:

Simple maintenance of the device from the front and rear, so that cable routes and aisle containments can be laid above the unit.

The fans can be replaced without using any tools

When operating with a water inlet temperature below the dew point, we recommend device 3312.550 (300 x 2000 x 1200 mm) with a novel and patented condensate management system.

Available expansion height of the adjacent server rack: free (Standard: 42 U) Dimensions: W x H x D: 300 x 2000 x 1200 mm Weight: approx. 200 kg

Optional: Fan module for cooling power expansion: 3312.016 Touchscreen display, colour: 3311.030 Connection hose, bottom/top: 3311.040 Condensate pump 3312.012 LCP Inline CW filter mat holder 3311.042 Filter mat 3311.043 Integrated spray separator on request